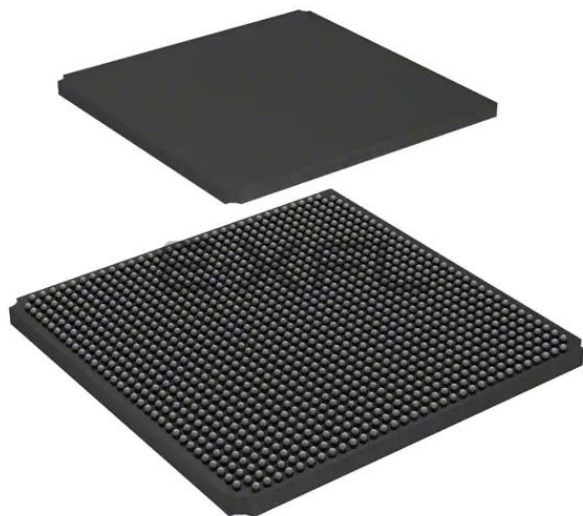




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	11875
Number of Logic Elements/Cells	95000
Total RAM Bits	5435392
Number of I/O	520
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	1152-BBGA
Supplier Device Package	1152-FPBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2m100e-5f1152i

one clock is selected for each input register, pipeline register and output register. Similarly Clock enable (CE) and Reset (RST) are selected from their four respective sources (CE0, CE1, CE2, CE3 and RST0, RST1, RST2, RST3) at each input register, pipeline register and output register.

Signed and Unsigned with Different Widths

The DSP block supports different widths of signed and unsigned multipliers besides x9, x18 and x36 widths. For unsigned operands, unused upper data bits should be filled to create a valid x9, x18 or x36 operand. For signed two's complement operands, sign extension of the most significant bit should be performed until x9, x18 or x36 width is reached. Table 2-8 provides an example of this.

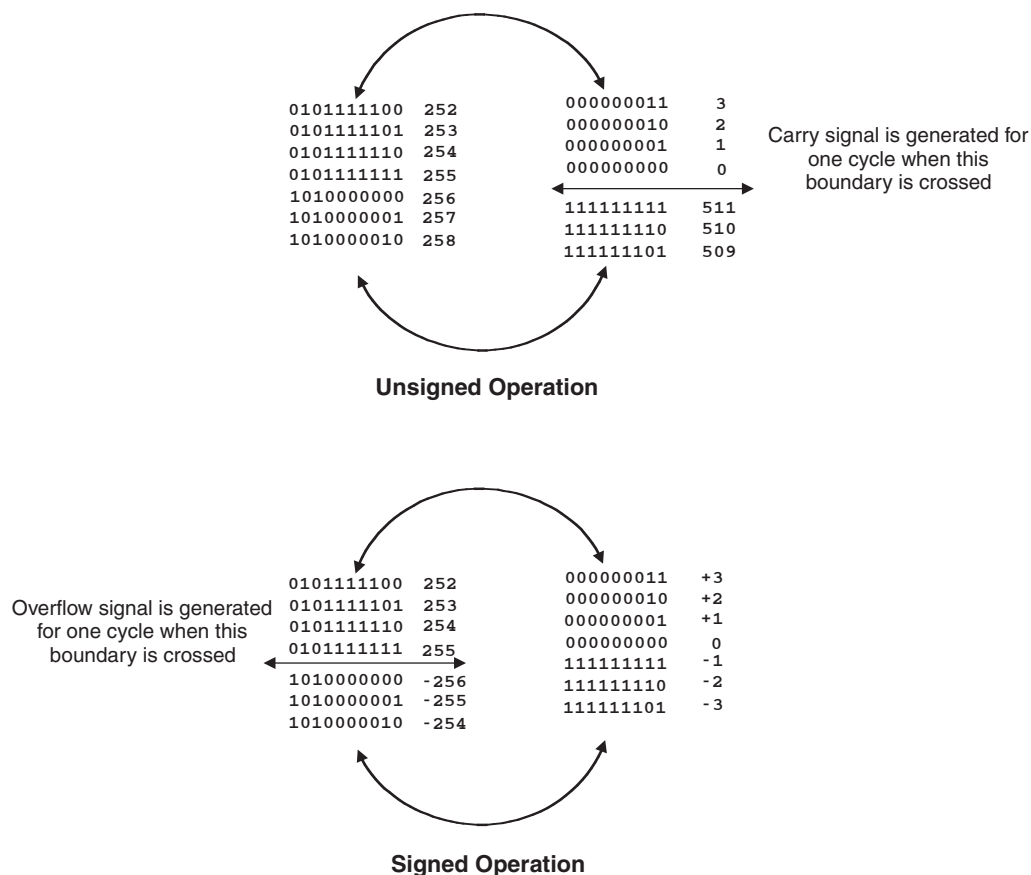
Table 2-8. Sign Extension Example

Number	Unsigned	Unsigned 9-bit	Unsigned 18-bit	Signed	Two's Complement Signed 9 Bits	Two's Complement Signed 18 Bits
+5	0101	000000101	0000000000000000101	0101	000000101	0000000000000000101
-6	N/A	N/A	N/A	1010	11111010	111111111111111010

OVERFLOW Flag from MAC

The sysDSP block provides an overflow output to indicate that the accumulator has overflowed. When two unsigned numbers are added and the result is a smaller number than the accumulator, “roll-over” is said to have occurred and an overflow signal is indicated. When two positive numbers are added with a negative sum and when two negative numbers are added with a positive sum, then the accumulator “roll-over” is said to have occurred and an overflow signal is indicated. Note that when overflow occurs the overflow flag is present for only one cycle. By counting these overflow pulses in FPGA logic, larger accumulators can be constructed. The conditions overflow signals for signed and unsigned operands are listed in Figure 2-27.

Figure 2-27. Accumulator Overflow/Underflow



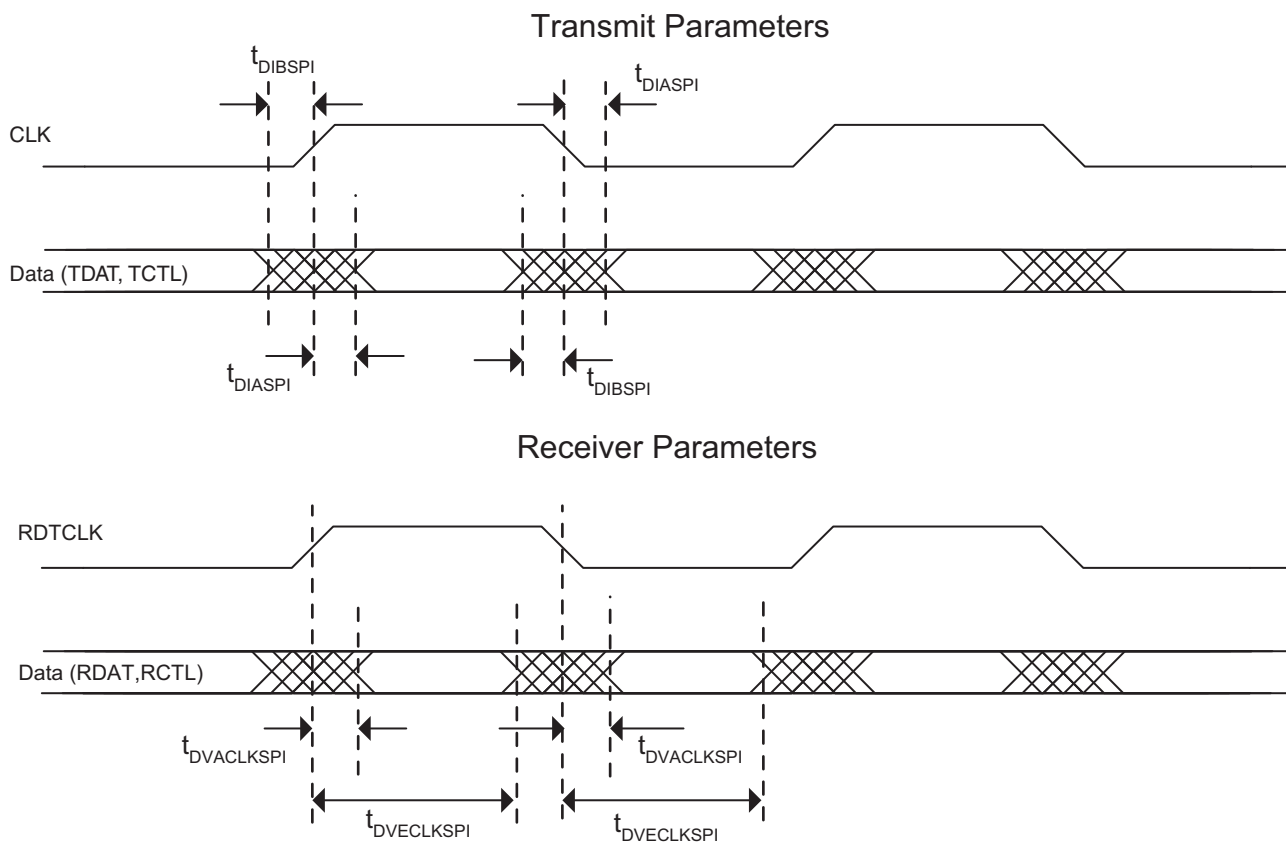
Register-to-Register Performance (Continued)

Function	-7 Timing	Units
36x36 Multiplier (All Registers)	372	MHz
18x18 Multiplier/Accumulate (Input and Output Registers)	295	MHz
18x18 Multiplier-Add/Sub-Sum (All Reg- isters)	420	MHz
DSP IP Functions		
16-Tap Fully-Parallel FIR Filter	304	MHz
1024-pt, Radix 4, Decimation in Frequency FFT	227	MHz
8x8 Matrix Multiplier	223	MHz

Derating Timing Tables

Logic timing provided in the following sections of this data sheet and the Diamond design tool are worst case numbers in the operating range. Actual delays at nominal temperature and voltage for best case process, can be much better than the values given in the tables. The Diamond design tool can provide logic timing numbers at a particular temperature and voltage.

Figure 3-6. SPI4.2 Parameters



LatticeECP2/M sysCONFIG Port Timing Specifications (Continued)

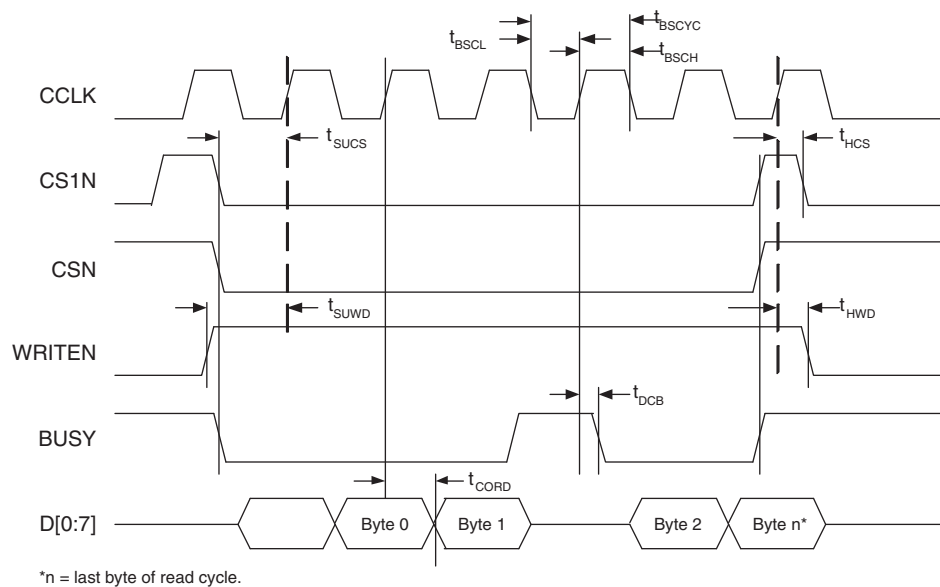
Over Recommended Operating Conditions

Parameter	Description	Min.	Max.	Units
f_{MAXSPI}	Max. CCLK Frequency - SPI Flash Read Opcode (0x03) (SPIFASTN = 1)	—	20	MHz
	Max. CCLK Frequency - SPI Flash Fast Read Opcode (0x0B) (SPIFASTN = 0)	—	50	MHz
	Max. CCLK Frequency - Encrypted Bitstream	—	10	MHz
t_{SUSPI}	SOSPI Data Setup Time Before CCLK	7	—	ns
t_{HSPI}	SOSPI Data Hold Time After CCLK	2	—	ns
t_{SUMCDI}	DI Setup to CCLK	7	—	ns
t_{HMCDI}	DI Hold from CCLK	1	—	ns

1. Re-toggling the PROGRAMN pin is not permitted until the INITN pin is high. Avoid consecutive toggling of the PROGRAMN.
2. For SED (Soft Error Detect), the SEDCLKIN operating frequency must be at least 20MHz. SEDCLKIN is derived from Master Clock Frequency that has a +/-30% variation..

Parameter	Min.	Max.	Units
Master Clock Frequency	Selected value - 30%	Selected value + 30%	MHz
Duty Cycle	40	60	%

Figure 3-14. sysCONFIG Parallel Port Read Cycle



LatticeECP2 Pin Information Summary, LFE2-20 and LFE2-35

Pin Type		LFE2-20				LFE2-35	
		208 PQFP	256 fpBGA	484 fpBGA	672 fpBGA	484 fpBGA	672 fpBGA
Single Ended User I/O		131	193	331	402	331	450
Differential Pair User I/O		62	96	165	200	165	224
Configuration	TAP Pins	5	5	5	5	5	5
	Muxed Pins	14	14	14	14	14	14
	Dedicated Pins (Non TAP)	7	7	7	7	7	7
Non Configuration	Muxed Pins	42	54	60	64	60	68
	Dedicated Pins	3	3	3	3	3	3
VCC		14	7	18	24	16	22
VCCAUX		8	4	16	16	16	16
VCCPLL		0	0	0	0	2	2
VCCIO	Bank0	2	2	4	5	4	5
	Bank1	2	2	4	5	4	5
	Bank2	2	2	4	5	4	5
	Bank3	2	2	4	5	4	5
	Bank4	2	2	4	5	4	5
	Bank5	2	2	4	5	4	5
	Bank6	2	2	4	5	4	5
	Bank7	2	2	4	5	4	5
	Bank8	2	1	2	2	2	2
GND, GND0 to GND7		22	20	60	72	60	72
NC		0	1	8	101	8	102
Single Ended/ Differential I/O Pairs per Bank (including emulated with resistors)	Bank0	18/9	18/9	50/25	67/33	50/25	67/33
	Bank1	18/9	34/17	46/23	52/26	46/23	52/26
	Bank2	11/5	20/10	34/17	36/18	34/17	48/24
	Bank3	11/5	12/6	22/11	32/16	22/11	42/21
	Bank4	19/9	32/16	46/23	50/25	46/23	54/27
	Bank5	18/9	17/8	46/23	68/34	46/23	68/34
	Bank6	18/8	26/13	40/20	48/24	40/20	58/29
	Bank7	12/6	20/10	33/16	35/17	33/16	47/23
	Bank8	6/2	14/7	14/7	14/7	14/7	14/7
True LVDS I/O Pairs per Bank	Bank0 (Top Edge)	0	0	0	0	0	0
	Bank1 (Top Edge)	0	0	0	0	0	0
	Bank2 (Right Edge)	4	5	9	9	9	12
	Bank3 (Right Edge)	3	3	5	8	5	9
	Bank4 (Bottom Edge)	0	0	0	0	0	0
	Bank5 (Bottom Edge)	0	0	0	0	0	0
	Bank6 (Left Edge)	6	7	10	12	10	13
	Bank7 (Left Edge)	5	5	8	8	8	11
	Bank8 (Right Edge)	0	0	0	0	0	0

LatticeECP2 Pin Information Summary, LFE2-50 and LFE2-70 (Cont.)

Pin Type		LFE2-50		LFE2-70	
		484 fpBGA	672 fpBGA	672 fpBGA	900 fpBGA
Available DDR-Interfaces per I/O Bank ¹	Bank0	0	0	0	0
	Bank1	0	0	0	0
	Bank2	2	3	3	4
	Bank3	0	3	3	3
	Bank4	3	4	4	4
	Bank5	3	4	4	5
	Bank6	1	4	4	4
	Bank7	2	3	3	4
	Bank8	0	0	0	0
PCI Capable I/Os per Bank	Bank0	0	0	0	0
	Bank1	0	0	0	0
	Bank2	0	0	0	0
	Bank3	0	0	0	0
	Bank4	46	62	62	72
	Bank5	46	68	68	80
	Bank6	0	0	0	0
	Bank7	0	0	0	0
	Bank8	0	0	0	0

1. Minimum requirement to implement a fully functional 8-bit wide DDR bus. Available DDR interface consists of at least 12 I/Os (1 DQS + 1 DQSB + 8 DQs + 1 DM + Bank VREF1).

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 144 TQFP (Cont.)

LFE2-6E/SE					LFE2-12E/12SE			
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential
46	NC	5			PB16B	5	BDQ15	C
47	GND	-			GND	-		
48	VCC				VCC	-		
49	PB8A	5	PCLKT5_0/BDQ6	T	PB26A	5	PCLKT5_0/BDQ24	T
50	PB8B	5	PCLKC5_0/BDQ6	C	PB26B	5	PCLKC5_0/BDQ24	C
51	GND	-			GND	-		
52	PB13A	4	PCLKT4_0/BDQ15	T	PB31A	4	PCLKT4_0/BDQ33	T
53	PB13B	4	PCLKC4_0/BDQ15	C	PB31B	4	PCLKC4_0/BDQ33	C
54	VCC	-			VCC	-		
55	PB14A	4	BDQ15	T	PB34A	4	BDQ33	T
56	PB14B	4	BDQ15	C	PB34B	4	BDQ33	C
57	PB16A	4	BDQ15	T	PB40A	4	BDQ42	T
58	PB16B	4	BDQ15	C	PB40B	4	BDQ42	C
59	PB18A	4	BDQ15	T	PB44A	4	BDQ42	T
60	PB18B	4	BDQ15	C	PB44B	4	BDQ42	C
61	GND	-			GND	-		
62	PB20A	4	BDQ24	T	PB48A	4	BDQ51	T
63	PB20B	4	BDQ24	C	PB48B	4	BDQ51	C
64	VCCIO4	4			VCCIO4	4		
65	PB22A	4	BDQ24	T	PB50A	4	BDQ51	T
66	PB22B	4	BDQ24	C	PB50B	4	BDQ51	C
67	PB24A	4	BDQS24	T	PB52A	4	BDQ51	T
68	PB24B	4	BDQ24	C	PB52B	4	BDQ51	C
69	PB26A	4	BDQ24	T	PB54A	4	BDQ51	T
70	PB26B	4	BDQ24	C	PB54B	4	BDQ51	C
71	PB28A	4	VREF2_4/BDQ24	T	PB55A	4	VREF2_4/BDQ51	T
72	PB28B	4	VREF1_4/BDQ24	C	PB55B	4	VREF1_4/BDQ51	C
73	CFG1	8			CFG1	8		
74	CFG2	8			CFG2	8		
75	PROGRAMN	8			PROGRAMN	8		
76	INITN	8			INITN	8		
77	CFG0	8			CFG0	8		
78	CCLK	8			CCLK	8		
79	DONE	8			DONE	8		
80	PR29A	8	D0/SPIFASTN		PR29A	8	D0/SPIFASTN	
81	GND	-			GND	-		
82	PR26A	8	D6		PR26A	8	D6	
83	VCC	-			VCC	-		
84	PR25B	8	D7/SPID0	C	PR25B	8	D7/SPID0	C
85	VCCIO8	8			VCCIO8	8		
86	PR25A	8	DI/CSSPI0N	T	PR25A	8	DI/CSSPI0N	T
87	PR24B	8	DOOUT/CSON	C	PR24B	8	DOOUT/CSON	C
88	PR24A	8	BUSY/SISPI	T	PR24A	8	BUSY/SISPI	T
89	VCCIO3	3			VCCIO3	3		
90	VCCAUX	-			VCCAUX	-		

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 208 PQFP (Cont.)

LFE2-12E/SE					LFE2-20E/SE				
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential	
184	GND	-			GND	-			
185	PT28A	0	PCLKT0_0	T	PT37A	0	PCLKT0_0	T	
186	PT26B	0		C	PT36B	0		C	
187	PT26A	0		T	PT36A	0		T	
188	VCC	-			VCC	-			
189	PT20B	0		C	PT30B	0		C	
190	VCCAUX	-			VCCAUX	-			
191	PT20A	0		T	PT30A	0		T	
192	GND	-			GND	-			
193	PT18B	0		C	PT26B	0		C	
194	PT18A	0		T	PT26A	0		T	
195	VCCIO0	0			VCCIO0	0			
196	PT16B	0		C	PT20B	0		C	
197	PT16A	0		T	PT20A	0		T	
198	VCC	-			VCC	-			
199	PT12B	0		C	PT12B	0		C	
200	PT12A	0		T	PT12A	0		T	
201	GND	-			GND	-			
202	PT8B	0		C	PT8B	0		C	
203	PT8A	0		T	PT8A	0		T	
204	PT6B	0		C	PT6B	0		C	
205	PT6A	0		T	PT6A	0		T	
206	VCCIO0	0			VCCIO0	0			
207	PT2B	0	VREF2_0	C	PT2B	0	VREF2_0	C	
208	PT2A	0	VREF1_0	T	PT2A	0	VREF1_0	T	

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-35E/SE					LFE2-50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
J22	PR29B	3	RDQ31	C (LVDS)*	PR48B	3	RDQ50	C (LVDS)*
H22	PR29A	3	RDQ31	T (LVDS)*	PR48A	3	RDQ50	T (LVDS)*
VCCIO	VCCIO3	3			VCCIO	3		
M20	PR28B	3	VREF2_3/RDQ31	C	PR47B	3	VREF2_3/RDQ50	C
L21	PR28A	3	VREF1_3/RDQ31	T	PR47A	3	VREF1_3/RDQ50	T
K21	PR27B	3	PCLKC3_0/RDQ31	C (LVDS)*	PR46B	3	PCLKC3_0/RDQ50	C (LVDS)*
J21	PR27A	3	PCLKT3_0/RDQ31	T (LVDS)*	PR46A	3	PCLKT3_0/RDQ50	T (LVDS)*
M18	PR25B	2	PCLKC2_0/RDQ22	C	PR44B	2	PCLKC2_0/RDQ41	C
L17	PR25A	2	PCLKT2_0/RDQ22	T	PR44A	2	PCLKT2_0/RDQ41	T
GNDIO	GNDIO2	-			GNDIO2	-		
L19	PR24B	2	RDQ22	C (LVDS)*	PR43B	2	RDQ41	C (LVDS)*
L20	PR24A	2	RDQ22	T (LVDS)*	PR43A	2	RDQ41	T (LVDS)*
L18	PR23B	2	RDQ22	C	PR42B	2	RDQ41	C
K17	PR23A	2	RDQ22	T	PR42A	2	RDQ41	T
VCCIO	VCCIO2	2			VCCIO	2		
K18	PR22B	2	RDQ22	C (LVDS)*	PR41B	2	RDQ41	C (LVDS)*
K19	PR22A	2	RDQS22	T (LVDS)*	PR41A	2	RDQS41	T (LVDS)*
G22	PR21B	2	RDQ22	C	PR40B	2	RDQ41	C
GNDIO	GNDIO2	-			GNDIO2	-		
F22	PR21A	2	RDQ22	T	PR40A	2	RDQ41	T
J17	PR20B	2	RDQ22	C (LVDS)*	PR39B	2	RDQ41	C (LVDS)*
J18	PR20A	2	RDQ22	T (LVDS)*	PR39A	2	RDQ41	T (LVDS)*
K20	PR19B	2	RDQ22	C	PR38B	2	RDQ41	C
VCCIO	VCCIO2	2			VCCIO	2		
J19	PR19A	2	RDQ22	T	PR38A	2	RDQ41	T
H21	PR18B	2	RDQ22	C (LVDS)*	PR37B	2	RDQ41	C (LVDS)*
G21	PR18A	2	RDQ22	T (LVDS)*	PR37A	2	RDQ41	T (LVDS)*
-	-	-			GNDIO2	-		
-	-	-			VCCIO	2		
H17	NC	-			PR26B	2	RUM0_SPLLC_FB_A/RDQ24	C
H16	NC	-			PR26A	2	RUM0_SPLLT_FB_A/RDQ24	T
H20	NC	-			PR25B	2	RUM0_SPLLC_IN_A/RDQ24	C
H18	NC	-			PR25A	2	RUM0_SPLLT_IN_A/RDQ24	T
-	-	-			GNDIO2	-		
-	-	-			VCCIO	2		
F21	PR17B	2	RDQ14	C	PR19B	2	RDQ16	C
GNDIO	GNDIO2	-			GNDIO2	-		
E22	PR17A	2	RDQ14	T	PR19A	2	RDQ16	T
D22	PR16B	2	RDQ14	C (LVDS)*	PR18B	2	RDQ16	C (LVDS)*
E21	PR16A	2	RDQ14	T (LVDS)*	PR18A	2	RDQ16	T (LVDS)*
G20	PR15B	2	RDQ14	C	PR17B	2	RDQ16	C
VCCIO	VCCIO2	2			VCCIO	2		
F20	PR15A	2	RDQ14	T	PR17A	2	RDQ16	T
H19	PR14B	2	RDQ14	C (LVDS)*	PR16B	2	RDQ16	C (LVDS)*
G19	PR14A	2	RDQS14	T (LVDS)*	PR16A	2	RDQS16	T (LVDS)*
GNDIO	GNDIO2	-			GNDIO2	-		

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-35E/SE					LFE2-50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
G17	PR13B	2	RDQ14	C	PR15B	2	RDQ16	C
F19	PR13A	2	RDQ14	T	PR15A	2	RDQ16	T
E20	PR12B	2	RDQ14	C (LVDS)*	PR14B	2	RDQ16	C (LVDS)*
D20	PR12A	2	RDQ14	T (LVDS)*	PR14A	2	RDQ16	T (LVDS)*
VCCIO	VCCIO2	2			VCCIO	2		
F18	PR11B	2	RDQ14	C	PR13B	2	RDQ16	C
F16	PR11A	2	RDQ14	T	PR13A	2	RDQ16	T
C21	PR10B	2	RDQ14	C (LVDS)*	PR12B	2	RDQ16	C (LVDS)*
C22	PR10A	2	RDQ14	T (LVDS)*	PR12A	2	RDQ16	T (LVDS)*
VCCIO	VCCIO2	2			VCCIO	2		
GNDIO	GNDIO2	-			GNDIO2	-		
D19	PR2B	2	VREF2_2/RDQ6	C (LVDS)*	PR2B	2	VREF2_2	C (LVDS)*
E19	PR2A	2	VREF1_2/RDQ6	T (LVDS)*	PR2A	2	VREF1_2	T (LVDS)*
B21	PT73B	1	VREF2_1	C	PT82B	1	VREF2_1	C
GNDIO	GNDIO1	-			GNDIO1	-		
B22	PT73A	1	VREF1_1	T	PT82A	1	VREF1_1	T
C20	PT72B	1		C	PT81B	1		C
C19	PT72A	1		T	PT81A	1		T
D18	PT71B	1		C	PT80B	1		C
VCCIO	VCCIO1	1			VCCIO	1		
E18	PT71A	1		T	PT80A	1		T
B20	PT70B	1		C	PT79B	1		C
A19	PT70A	1		T	PT79A	1		T
D17	PT69B	1		C	PT78B	1		C
C18	PT69A	1		T	PT78A	1		T
A21	PT68B	1		C	PT77B	1		C
GNDIO	GNDIO1	-			GNDIO1	-		
A20	PT68A	1		T	PT77A	1		T
A18	PT67B	1		C	PT76B	1		C
VCCIO	VCCIO1	1			VCCIO	1		
B18	PT67A	1		T	PT76A	1		T
G16	PT66B	1		C	PT75B	1		C
G15	PT66A	1		T	PT75A	1		T
D16	PT65B	1		C	PT74B	1		C
E16	PT65A	1		T	PT74A	1		T
GNDIO	GNDIO1	-			GNDIO1	-		
VCCIO	VCCIO1	1			VCCIO	1		
C17	PT55B	1		C	PT64B	1		C
GNDIO	GNDIO1	-			GNDIO1	-		
C16	PT55A	1		T	PT64A	1		T
B17	PT54B	1		C	PT63B	1		C
B16	PT54A	1		T	PT63A	1		T
A17	PT53B	1		C	PT62B	1		C
VCCIO	VCCIO1	1			VCCIO	1		
A16	PT53A	1		T	PT62A	1		T
C15	PT52B	1		C	PT61B	1		C

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
L2	NC	-			NC	-		
L1	NC	-			NC	-		
VCCIO	VCCIO7	7			VCCIO7	7		
M2	NC	-			NC	-		
M1	NC	-			NC	-		
N2	NC	-			NC	-		
GND	GNDIO7	-			GNDIO7	-		
M8	VCC	-			NC	-		
VCCIO	VCCIO7	7			VCCIO7	7		
GND	GNDIO7	-			GNDIO7	-		
N1	PL12A	7	LDQ16		PL18A	7	LDQ22	
L8	PL13A	7	LDQ16	T	PL19A	7	LDQ22	T
K8	PL13B	7	LDQ16	C	PL19B	7	LDQ22	C
VCCIO	VCCIO7	7			VCCIO7	7		
L6	PL14A	7	LDQ16	T (LVDS)*	PL20A	7	LDQ22	T (LVDS)*
K5	PL14B	7	LDQ16	C (LVDS)*	PL20B	7	LDQ22	C (LVDS)*
L7	PL15A	7	LDQ16	T	PL21A	7	LDQ22	T
L5	PL15B	7	LDQ16	C	PL21B	7	LDQ22	C
GND	GNDIO7	-			GNDIO7	-		
P1	PL16A	7	LDQS16	T (LVDS)*	PL22A	7	LDQS22	T (LVDS)*
P2	PL16B	7	LDQ16	C (LVDS)*	PL22B	7	LDQ22	C (LVDS)*
M6	PL17A	7	LDQ16	T	PL23A	7	LDQ22	T
VCCIO	VCCIO7	7			VCCIO7	7		
N8	PL17B	7	LDQ16	C	PL23B	7	LDQ22	C
R1	PL18A	7	LDQ16	T (LVDS)*	PL24A	7	LDQ22	T (LVDS)*
R2	PL18B	7	LDQ16	C (LVDS)*	PL24B	7	LDQ22	C (LVDS)*
M7	PL19A	7	PCLKT7_0/LDQ16	T	PL25A	7	PCLKT7_0/LDQ22	T
GND	GNDIO7	-			GNDIO7	-		
N9	PL19B	7	PCLKC7_0/LDQ16	C	PL25B	7	PCLKC7_0/LDQ22	C
M4	PL21A	6	PCLKT6_0/LDQ25	T (LVDS)*	PL27A	6	PCLKT6_0/LDQ31	T (LVDS)*
M5	PL21B	6	PCLKC6_0/LDQ25	C (LVDS)*	PL27B	6	PCLKC6_0/LDQ31	C (LVDS)*
N7	PL22A	6	VREF2_6/LDQ25	T	PL28A	6	VREF2_6/LDQ31	T
P9	PL22B	6	VREF1_6/LDQ25	C	PL28B	6	VREF1_6/LDQ31	C
N3	PL23A	6	LDQ25	T (LVDS)*	PL29A	6	LDQ31	T (LVDS)*
VCCIO	VCCIO6	6			VCCIO6	6		
N4	PL23B	6	LDQ25	C (LVDS)*	PL29B	6	LDQ31	C (LVDS)*
N5	PL24A	6	LDQ25	T	PL30A	6	LDQ31	T
P7	PL24B	6	LDQ25	C	PL30B	6	LDQ31	C
T1	NC	-			PL31A	6	LDQS31	T (LVDS)*
GND	GNDIO6	-			GNDIO6	-		
T2	NC	-			PL31B	6	LDQ31	C (LVDS)*
P8	NC	-			PL32A	6	LDQ31	T
P6	NC	-			PL32B	6	LDQ31	C
VCCIO	VCCIO6	6			VCCIO6	6		
P5	NC	-			PL33A	6	LDQ31	T (LVDS)*
P4	NC	-			PL33B	6	LDQ31	C (LVDS)*

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
AE17	PB51B	4	BDQ51	C	PB51B	4	BDQ51	C	
AB19	PB52A	4	BDQ51	T	PB52A	4	BDQ51	T	
AE19	PB52B	4	BDQ51	C	PB52B	4	BDQ51	C	
AF17	PB53A	4	BDQ51	T	PB53A	4	BDQ51	T	
AE18	PB53B	4	BDQ51	C	PB53B	4	BDQ51	C	
VCCIO	VCCIO4	4			VCCIO4	4			
W16	PB54A	4	BDQ51	T	PB54A	4	BDQ51	T	
AA17	PB54B	4	BDQ51	C	PB54B	4	BDQ51	C	
AF18	PB55A	4	BDQ51	T	PB55A	4	BDQ51	T	
AF19	PB55B	4	BDQ51	C	PB55B	4	BDQ51	C	
GND	GNDIO4	-			GNDIO4	-			
AA19	NC	-			PB56A	4	BDQ60	T	
W17	NC	-			PB56B	4	BDQ60	C	
Y19	NC	-			PB57A	4	BDQ60	T	
Y17	NC	-			PB57B	4	BDQ60	C	
AF20	NC	-			NC	-			
VCCIO	VCCIO4	4			VCCIO4	4			
AE20	NC	-			NC	-			
AA20	NC	-			NC	-			
W18	NC	-			NC	-			
AD20	NC	-			NC	-			
GND	GNDIO4	-			GNDIO4	-			
AE21	NC	-			NC	-			
AF21	NC	-			NC	-			
AF22	NC	-			NC	-			
VCCIO	VCCIO4	4			VCCIO4	4			
GND	GNDIO4	-			GNDIO4	-			
AE22	PB56A	4	BDQ60	T	PB65A	4	BDQ69	T	
AD22	PB56B	4	BDQ60	C	PB65B	4	BDQ69	C	
AF23	PB57A	4	BDQ60	T	PB66A	4	BDQ69	T	
AE23	PB57B	4	BDQ60	C	PB66B	4	BDQ69	C	
AD23	PB58A	4	BDQ60	T	PB67A	4	BDQ69	T	
AC23	PB58B	4	BDQ60	C	PB67B	4	BDQ69	C	
VCCIO	VCCIO4	4			VCCIO4	4			
AB20	PB59A	4	BDQ60	T	PB68A	4	BDQ69	T	
AC20	PB59B	4	BDQ60	C	PB68B	4	BDQ69	C	
GND	GNDIO4	-			GNDIO4	-			
AB21	PB60A	4	BDQS60	T	PB69A	4	BDQS69	T	
AC22	PB60B	4	BDQ60	C	PB69B	4	BDQ69	C	
W19	PB61A	4	BDQ60	T	PB70A	4	BDQ69	T	
AA21	PB61B	4	BDQ60	C	PB70B	4	BDQ69	C	
AF24	PB62A	4	BDQ60	T	PB71A	4	BDQ69	T	
AE24	PB62B	4	BDQ60	C	PB71B	4	BDQ69	C	
VCCIO	VCCIO4	4			VCCIO4	4			
Y20	PB63A	4	BDQ60	T	PB72A	4	BDQ69	T	
AB22	PB63B	4	BDQ60	C	PB72B	4	BDQ69	C	

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
A2	GND	-			GND	-		
A25	GND	-			GND	-		
AA18	GND	-			GND	-		
AA24	GND	-			GND	-		
AA3	GND	-			GND	-		
AA9	GND	-			GND	-		
AD11	GND	-			GND	-		
AD16	GND	-			GND	-		
AD21	GND	-			GND	-		
AD6	GND	-			GND	-		
AE1	GND	-			GND	-		
AE26	GND	-			GND	-		
AF2	GND	-			GND	-		
AF25	GND	-			GND	-		
B1	GND	-			GND	-		
B26	GND	-			GND	-		
C11	GND	-			GND	-		
C16	GND	-			GND	-		
C21	GND	-			GND	-		
C6	GND	-			GND	-		
F18	GND	-			GND	-		
F24	GND	-			GND	-		
F3	GND	-			GND	-		
F9	GND	-			GND	-		
J13	GND	-			GND	-		
J14	GND	-			GND	-		
J21	GND	-			GND	-		
J6	GND	-			GND	-		
K10	GND	-			GND	-		
K11	GND	-			GND	-		
K13	GND	-			GND	-		
K14	GND	-			GND	-		
K16	GND	-			GND	-		
K17	GND	-			GND	-		
L10	GND	-			GND	-		
L11	GND	-			GND	-		
L16	GND	-			GND	-		
L17	GND	-			GND	-		
L24	GND	-			GND	-		
L3	GND	-			GND	-		
M13	GND	-			GND	-		
M14	GND	-			GND	-		
N10	GND	-			GND	-		
N12	GND	-			GND	-		
N13	GND	-			GND	-		
N14	GND	-			GND	-		

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
N15	GND	-			GND	-		
N17	GND	-			GND	-		
P10	GND	-			GND	-		
P12	GND	-			GND	-		
P13	GND	-			GND	-		
P14	GND	-			GND	-		
P15	GND	-			GND	-		
P17	GND	-			GND	-		
R13	GND	-			GND	-		
R14	GND	-			GND	-		
T10	GND	-			GND	-		
T11	GND	-			GND	-		
T16	GND	-			GND	-		
T17	GND	-			GND	-		
T24	GND	-			GND	-		
T3	GND	-			GND	-		
U10	GND	-			GND	-		
U11	GND	-			GND	-		
U13	GND	-			GND	-		
U14	GND	-			GND	-		
U16	GND	-			GND	-		
U17	GND	-			GND	-		
V13	GND	-			GND	-		
V14	GND	-			GND	-		
V21	GND	-			GND	-		
V6	GND	-			GND	-		
M3	NC	-			NC	-		
N6	NC	-			NC	-		
P24	NC	-			NC	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
V23	PR70A	3	RDQ71	T
W27	PR69B	3	RDQ71	C (LVDS)*
W28	PR69A	3	RDQ71	T (LVDS)*
V26	PR68B	3	RDQ71	C
VCCIO	VCCIO3	3		
V24	PR68A	3	RDQ71	T
W29	PR67B	3	RDQ71	C (LVDS)*
W30	PR67A	3	RDQ71	T (LVDS)*
U25	PR66B	3	RDQ63	C
GND	GNDIO3	-		
U23	PR66A	3	RDQ63	T
V29	PR65B	3	RDQ63	C (LVDS)*
V30	PR65A	3	RDQ63	T (LVDS)*
U26	PR64B	3	RDQ63	C
VCCIO	VCCIO3	3		
U24	PR64A	3	RDQ63	T
U27	PR63B	3	RDQ63	C (LVDS)*
U28	PR63A	3	RDQS63	T (LVDS)*
GND	GNDIO3	-		
T23	PR62B	3	RDQ63	C
T25	PR62A	3	RDQ63	T
U29	PR61B	3	RDQ63	C (LVDS)*
U30	PR61A	3	RDQ63	T (LVDS)*
VCCIO	VCCIO3	3		
T24	PR60B	3	VREF2_3/RDQ63	C
T26	PR60A	3	VREF1_3/RDQ63	T
T27	PR59B	3	PCLKC3_0/RDQ63	C (LVDS)*
T28	PR59A	3	PCLKT3_0/RDQ63	T (LVDS)*
R24	PR57B	2	PCLKC2_0/RDQ54	C
R26	PR57A	2	PCLKT2_0/RDQ54	T
GND	GNDIO2	-		
T29	PR56B	2	RDQ54	C (LVDS)*
T30	PR56A	2	RDQ54	T (LVDS)*
R23	PR55B	2	RDQ54	C
R25	PR55A	2	RDQ54	T
VCCIO	VCCIO2	2		
R27	PR54B	2	RDQ54	C (LVDS)*
R28	PR54A	2	RDQS54	T (LVDS)*
P26	PR53B	2	RDQ54	C
GND	GNDIO2	-		
P24	PR53A	2	RDQ54	T
R29	PR52B	2	RDQ54	C (LVDS)*
R30	PR52A	2	RDQ54	T (LVDS)*

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
V5	PL51A	6	LDQS51	T (LVDS)*	PL66A	6	LDQS66	T (LVDS)*	
U4	PL51B	6	LDQ51	C (LVDS)*	PL66B	6	LDQ66	C (LVDS)*	
V1	PL52A	6	LDQ51	T	PL67A	6	LDQ66	T	
VCCIO	VCCIO6	6			VCCIO6	6			
V3	PL52B	6	LDQ51	C	PL67B	6	LDQ66	C	
W1	PL53A	6	LDQ51	T (LVDS)*	PL68A	6	LDQ66	T (LVDS)*	
Y1	PL53B	6	LDQ51	C (LVDS)*	PL68B	6	LDQ66	C (LVDS)*	
AA1	PL54A	6	LDQ51	T	PL69A	6	LDQ66	T	
GNDIO	GNDIO6	-			GNDIO6	-			
AA2	PL54B	6	LDQ51	C	PL69B	6	LDQ66	C	
V4	TCK	-			TCK	-			
Y2	TDI	-			TDI	-			
Y3	TMS	-			TMS	-			
W3	TDO	-			TDO	-			
W4	VCCJ	-			VCCJ	-			
W5	PB2A	5	BDQ6	T	PB2A	5	BDQ6	T	
Y4	PB2B	5	BDQ6	C	PB2B	5	BDQ6	C	
W6	PB3A	5	BDQ6	T	PB3A	5	BDQ6	T	
V6	PB3B	5	BDQ6	C	PB3B	5	BDQ6	C	
AA3	PB4A	5	BDQ6	T	PB4A	5	BDQ6	T	
VCCIO	VCCIO5	5			VCCIO5	5			
AB2	PB4B	5	BDQ6	C	PB4B	5	BDQ6	C	
T8	PB5A	5	BDQ6	T	PB5A	5	BDQ6	T	
U7	PB5B	5	BDQ6	C	PB5B	5	BDQ6	C	
U8	PB6A	5	BDQS6	T	PB6A	5	BDQS6	T	
GNDIO	GNDIO5	-			GNDIO5	-			
T9	PB6B	5	BDQ6	C	PB6B	5	BDQ6	C	
V8	PB7A	5	BDQ6	T	PB7A	5	BDQ6	T	
W8	PB7B	5	BDQ6	C	PB7B	5	BDQ6	C	
Y6	PB8A	5	BDQ6	T	PB8A	5	BDQ6	T	
VCCIO	VCCIO5	5			VCCIO5	5			
Y5	PB8B	5	BDQ6	C	PB8B	5	BDQ6	C	
AB3	PB9A	5	BDQ6	T	PB9A	5	BDQ6	T	
AB4	PB9B	5	BDQ6	C	PB9B	5	BDQ6	C	
AB5	PB10A	5	BDQ6	T	PB10A	5	BDQ6	T	
GNDIO	GNDIO5	-			GNDIO5	-			
AA6	PB10B	5	BDQ6	C	PB10B	5	BDQ6	C	
V9	PB13A	5	BDQ15	T	PB31A	5	BDQ33	T	
U9	PB13B	5	BDQ15	C	PB31B	5	BDQ33	C	
VCCIO	VCCIO5	5			VCCIO5	5			
-	-	-			GNDIO5	-			
U10	PB14A	5	BDQ15	T	PB32A	5	BDQ33	T	
T10	PB14B	5	BDQ15	C	PB32B	5	BDQ33	C	
GNDIO	GNDIO5	-			GNDIO5	-			
W9	PB15A	5	BDQS15****	T	PB33A	5	BDQS33****	T	
Y8	PB15B	5	BDQ15	C	PB33B	5	BDQ33	C	
AA7	PB16A	5	VREF2_5/BDQ15	T	PB34A	5	VREF2_5/BDQ33	T	
Y7	PB16B	5	VREF1_5/BDQ15	C	PB34B	5	VREF1_5/BDQ33	C	

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
T17	PR51A	8	D2***	T	PR66A	8	D2***	T	
T22	PR50B	8	D3***	C	PR65B	8	D3***	C	
GNDIO	GNDIO8	-			GNDIO8	-			
R22	PR50A	8	D4***	T	PR65A	8	D4***	T	
T15	PR49B	8	D5***	C	PR64B	8	D5***	C	
R17	PR49A	8	D6***	T	PR64A	8	D6***	T	
T20	PR48B	8	D7/SPID0***	C	PR63B	8	D7/SPID0***	C	
VCCIO	VCCIO8	8			VCCIO8	8			
T21	PR48A	8	DI/CSSPI0N***	T	PR63A	8	DI/CSSPI0N***	T	
R21	PR47B	8	DOU/CSON/CSSPI1N***	C	PR62B	8	DOU/CSON/CSSPI1N***	C	
R20	PR47A	8	BUSY/SISPI***	T	PR62A	8	BUSY/SISPI***	T	
R16	RLM0_PLLCAP	3			RLM0_PLLCAP	3			
R18	PR45B	3	RLM0_GDLLC_FB_A	C	PR60B	3	RLM0_GDLLC_FB_A/RDQ57	C	
GNDIO	GNDIO3	-			GNDIO3	-			
R19	PR45A	3	RLM0_GDLLT_FB_A	T	PR60A	3	RLM0_GDLLT_FB_A/RDQ57	T	
P22	PR44B	3	RLM0_GDLLC_IN_A**	C (LVDS)*	PR59B	3	RLM0_GDLLC_IN_A**/RDQ57	C (LVDS)*	
P21	PR44A	3	RLM0_GDLLT_IN_A**	T (LVDS)*	PR59A	3	RLM0_GDLLT_IN_A**/RDQ57	T (LVDS)*	
P16	PR43B	3	RLM0_GPLLC_IN_A**	C	PR58B	3	RLM0_GPLLC_IN_A**/RDQ57	C	
VCCIO	VCCIO3	3			VCCIO3	3			
P17	PR43A	3	RLM0_GPLLT_IN_A**	T	PR58A	3	RLM0_GPLLT_IN_A**/RDQ57	T	
P20	PR42B	3	RLM0_GPLLC_FB_A	C (LVDS)*	PR57B	3	RLM0_GPLLC_FB_A/RDQ57	C (LVDS)*	
P19	PR42A	3	RLM0_GPLLT_FB_A	T (LVDS)*	PR57A	3	RLM0_GPLLT_FB_A/RDQS57****	T (LVDS)*	
GNDIO	GNDIO3	-			GNDIO3	-			
-	-	-			VCCIO3	3			
P18	PR41B	3	RDQ38	C	PR51B	3	RDQ48	C	
N16	PR41A	3	RDQ38	T	PR51A	3	RDQ48	T	
GNDIO	GNDIO3	-			GNDIO3	-			
N22	PR40B	3	RDQ38	C (LVDS)*	PR50B	3	RDQ48	C (LVDS)*	
N21	PR40A	3	RDQ38	T (LVDS)*	PR50A	3	RDQ48	T (LVDS)*	
N17	PR39B	3	RDQ38	C	PR49B	3	RDQ48	C	
N18	PR39A	3	RDQ38	T	PR49A	3	RDQ48	T	
VCCIO	VCCIO3	3			VCCIO3	3			
M22	PR38B	3	RDQ38	C (LVDS)*	PR48B	3	RDQ48	C (LVDS)*	
M21	PR38A	3	RDQS38	T (LVDS)*	PR48A	3	RDQS48	T (LVDS)*	
M16	PR37B	3	RDQ38	C	PR47B	3	RDQ48	C	
GNDIO	GNDIO3	-			GNDIO3	-			
M17	PR37A	3	RDQ38	T	PR47A	3	RDQ48	T	
M20	PR36B	3	RDQ38	C (LVDS)*	PR46B	3	RDQ48	C (LVDS)*	
M19	PR36A	3	RDQ38	T (LVDS)*	PR46A	3	RDQ48	T (LVDS)*	
M18	PR35B	3	RDQ38	C	PR45B	3	RDQ48	C	
VCCIO	VCCIO3	3			VCCIO3	3			
L16	PR35A	3	RDQ38	T	PR45A	3	RDQ48	T	
L22	PR34B	3	RDQ38	C (LVDS)*	PR44B	3	RDQ48	C (LVDS)*	
L21	PR34A	3	RDQ38	T (LVDS)*	PR44A	3	RDQ48	T (LVDS)*	
K22	PR32B	3	RLM1_SPLLC_FB_A	C	PR42B	3	RLM2_SPLLC_FB_A	C	
VCCIO	VCCIO3	3			VCCIO3	3			
K21	PR32A	3	RLM1_SPLLT_FB_A	T	PR42A	3	RLM2_SPLLT_FB_A	T	
L17	PR31B	3	RLM1_SPLLC_IN_A	C (LVDS)*	PR41B	3	RLM2_SPLLC_IN_A	C (LVDS)*	

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
A9	ULC_SQ_HDOUTP0	11		T
A10	ULC_SQ_VCCOB0	11		
B9	ULC_SQ_HDOUTN0	11		C
C9	ULC_SQ_VCCTX1	11		
B8	ULC_SQ_HDOUTN1	11		C
C8	ULC_SQ_VCCOB1	11		
A8	ULC_SQ_HDOUTP1	11		T
C12	ULC_SQ_VCCRX1	11		
B11	ULC_SQ_HDINN1	11		C
C11	ULC_SQ_VCCIB1	11		
A11	ULC_SQ_HDINP1	11		T
B7	ULC_SQ_VCCAUX33	11		
E7	ULC_SQ_REFCLKN	11		C
D7	ULC_SQ_REFCLKP	11		T
C7	ULC_SQ_VCCP	11		
A3	ULC_SQ_HDINP2	11		T
C3	ULC_SQ_VCCIB2	11		
B3	ULC_SQ_HDINN2	11		C
C2	ULC_SQ_VCCRX2	11		
A6	ULC_SQ_HDOUTP2	11		T
C6	ULC_SQ_VCCOB2	11		
B6	ULC_SQ_HDOUTN2	11		C
C5	ULC_SQ_VCCTX2	11		
B5	ULC_SQ_HDOUTN3	11		C
A4	ULC_SQ_VCCOB3	11		
A5	ULC_SQ_HDOUTP3	11		T
C4	ULC_SQ_VCCTX3	11		
B2	ULC_SQ_HDINN3	11		C
B1	ULC_SQ_VCCIB3	11		
A2	ULC_SQ_HDINP3	11		T
C1	ULC_SQ_VCCRX3	11		
L12	VCC	-		
L13	VCC	-		
L18	VCC	-		
L19	VCC	-		
M11	VCC	-		
M12	VCC	-		
M13	VCC	-		
M14	VCC	-		
M15	VCC	-		
M16	VCC	-		
M17	VCC	-		
M18	VCC	-		

Date	Version	Section	Change Summary
August 2006 (cont.)	01.1 (cont.)	Pinout Information (cont.)	Added Information on: Available Device Resources per Packaged Device table.
		Ordering Information	Updated ordering part number table to include ECP2-12.
			Updated topside mark drawing.
September 2006	02.0	Multiple	Added information regarding LatticeECP2M support throughout.
September 2006	02.1	DC and Switching Characteristics	Added Receiver Total Jitter Tolerance Specification table.
			Removed power-up requirements for proper configuration footnote in Recommended Operating Conditions table.
December 2006	02.2	Introduction	LatticeECP2M Selection Guide table has been updated.
		Architecture	Figure 2-16. Per Region Secondary Clock Selection has been updated.
			Figure 2-39. Simplified Channel Block Diagram for SERDES and PCS has been updated.
		DC and Switching	Footnotes have been added to Recommended Operating Conditions.
			DC Electrical Characteristics table has been updated.
			Supply Current (Standby) tables have been updated.
			Initialization Supply Current table have been updated.
			Updated timing numbers to include LFE2-12E (rev A 0.08).
		Pinout Information	Updated to include the entire ECP2 device information as well as 256-fpBGA and 484-fpBGA pin information for the ECP2M35E.
		Ordering Information	Updated to include the entire ECP2 and ECP2M device ordering information.
February 2007	02.3	Architecture	Updated EBR Asynchronous Reset section.
March 2007	02.4	DC and Switching Characteristics	Power-sequencing footnotes have been added to the Recommended Operating Conditions. DDR2 performance has been updated to 266MHz.
March 2007	02.5	Introduction	Added "Security Series" to the LatticeECP2 and LatticeECP2M families.
		Architecture	Enhanced Configuration Option section updated.
		DC and Switching	Recommended Operating Conditions table - footnote 4 updated.
		Ordering Information	"Security Series" ordering part numbers added.
April 2007	02.6	Introduction	LatticeECP2M family table has been updated for user I/O counts.
		Ordering Information	LatticeECP2M family ordering part number section has been updated to add 1152-fpBGA package for the ECP2M70 and ECP2M100.
July 2007	02.7	Architecture	Updated text in Ripple Mode section.
		DC and Switching	ECP2/M Supply Current information has been updated. Typical Building Block Function Performance, External Switching Characteristics, Internal Switching Characteristics, Family Timing Adders, sysCLOCK GPLL Timing, sysCLOCK SPLN Timing, DLL Timing and sysCONFIG Port Timing Specifications have been updated (timing rev. A 0.10). SERDES timing information has been updated. PCI Express timing information has been updated.
		Pinout Information	Added LatticeECP2M20 pinout information.
August 2007	02.8	Introduction	1156-fpBGA package option has been removed from the LatticeECP2M family.
		Architecture	Table 2-16. Selectable Master Clock (CCLK) Frequencies During Configuration table has been updated.
		DC and Switching	Supply Current (Standby) table has been updated.
			DSP Function timing has been updated.

Date	Version	Section	Change Summary
August 2007 (cont.)	02.8 (cont.)	DC and Switching (cont.)	sysCLOCK GPLL timing has been updated.
		Pinout Information	Added ECP2M50 (484/672/900-fpBGA), ECP2M70 (900-fpBGA) and ECP2M100 (900-fpBGA) pinout information.
		Ordering Information	1156-fpBGA package option has been removed from the LatticeECP2M family.
September 2007	02.9	Pinout Information	Added Thermal Management text section.
February 2008	03.0	Architecture	Added LVC MOS33D description.
		DC and Switching	LatticeECP2M Supply Current has been updated.
			Typical Building Block Function Performance, External Switching Characteristics, Internal Switching Characteristics, Family Timing Adders, sysCLOCK GPLL Timing, sysCLOCK SPLL Timing, DLL Timing and sysCONFIG Port Timing Specifications have been updated (timing rev. A 0.11).
			Figure 3-9. Read/Write Mode (Normal) and Figure 3-10. Read/Write Mode with Input and Output Registers have been updated.
			Table 3-8. Channel output Jitter (Max) has been updated.
		Pinout Information	Signal description has been updated.
April 2008	03.1	Pinout Information	Added 1152-fpBGA pinouts for the ECP2M70 and ECP2M100.
June 2008	03.2	Pinout Information	Available DDR Interfaces per I/O Bank for the LFE2M35 (484/672-fpBGA) have been updated.
		Introduction	Family Selection Guide table - Updated number of EBR SRAM Blocks for the ECP2-70 device.
		Architecture	Removed Read-Before-Write sysMEM EBR mode.
		Architecture	Clarification of the operation of the secondary clock regions.
August 2008	03.3	DC and Switching Characteristics	Removed Read-Before-Write sysMEM EBR mode.
		Architecture	Clarification of the operation of the secondary clock regions.
		Pinout Information	Added information for [LOC]DQ[num] to Signal Descriptions table.
January 2009	03.4	DC and Switching Characteristics	Updated typical and max. jitter numbers in Channel Output Jitter table for x10 mode.
			Added Channel Output Jitter table for x20 mode.
November 2009	03.5	DC and Switching Characteristics	Updated SPI/SPI _m Configuration Waveforms diagram.
			Updated footnotes in LatticeECP2 Initialization Supply Current table.
			Updated footnotes in LatticeECP2M Initialization Supply Current table.
			Updated footnotes in SERDES High Speed Data Receiver (LatticeECP2M Family Only) table.
			Updated max. value for t _{DINIT} parameter in LatticeECP2/M sysCONFIG Port Timing Specifications table.
			Updated Serial Output Timing and Levels table.
			Updated Figure 3-5 MLVDS
			Updated Table 3-7 Serial Output Timing and Levels
			Updated Table 3-15 Power Down/Power Up Specification
		Pinout Information	Signal Descriptions table - corrected references to ULM, URM, LRM (changed to LUM, RUM and RLM), added footnote 5.